

2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

Features

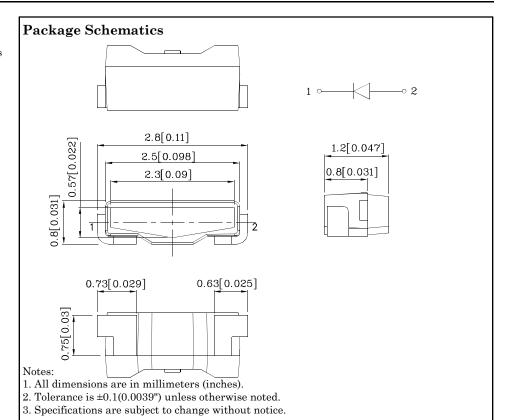
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- \bullet MSL (Moisture Sensitivity Level): 3
- RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Absolute Maximum Ratings (T _A =25°C)		Green (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	mA	
Power Dissipation	P_{D}	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)	Green (AlGaInP)	Unit		
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.1	V	
Forward Voltage (Max.) (I _F =20mA)	VE		V	
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	10	uA	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λΡ	574*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	570*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	20	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF	

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* $(I_F=20\text{mA})$ mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZVG81FS	Green	AlGaInP	Water Clear	20*	59*	574*	110°

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

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Handling Precautions

 $Compare \ to \ epoxy \ encapsulant \ that \ is \ hard \ and \ brittle, \ silicone \ is \ softer \ and \ flexible. \ Although \ its \ characteristic \ significantly \ reduces \ thermal \ stress, \ it \ is \ more \ susceptible \ to \ damage \ by \ external \ mechanical \ force.$

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



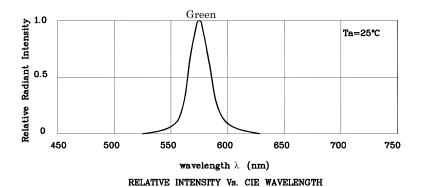
2. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

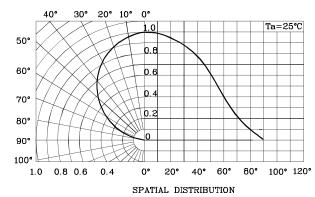
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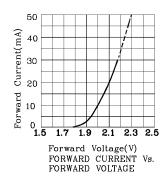


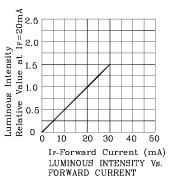


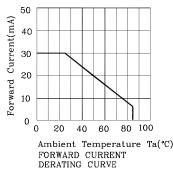


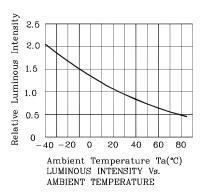


❖ Green



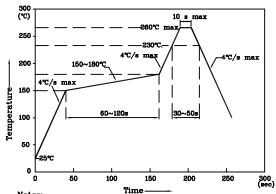






LED is recommended for reflow soldering and soldering profile is shown below.

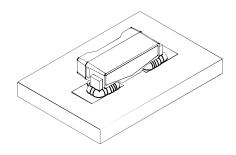
Reflow Soldering Profile for SMD Products (Pb-Free Components)



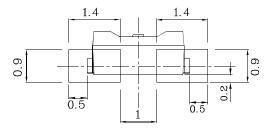
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



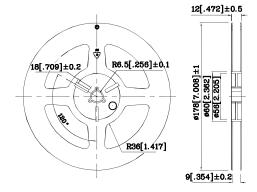
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



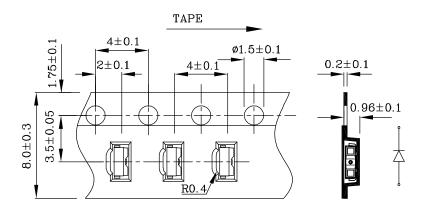
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

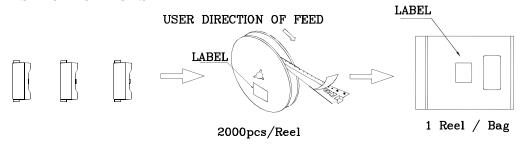
Note: Accuracy may depend on the sorting parameters.

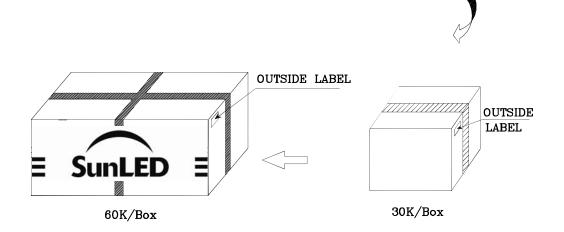
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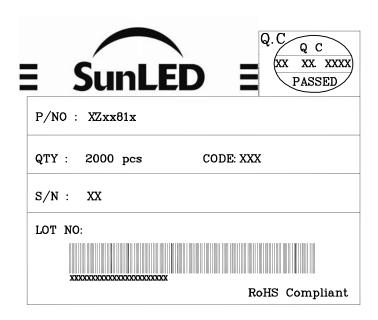




PACKING & LABEL SPECIFICATIONS







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